

Electronic Patent Application Fee Transmittal

Application Number:	10774869			
Filing Date:	09-Feb-2004			
Title of Invention:	Underfill process for flip-chip device			
First Named Inventor/Applicant Name:	Song-Hua Shi			
Filer:	Joseph P. Mehrle/Anne Richards			
Attorney Docket Number:	884.698US2			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Statutory disclaimer	1814	1	130	130
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				130